

L Number	Hits	Search Text	DB	Time stamp
1	4756	optoelectronic and lens\$2	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/28 12:14
3	2773	(solder near bump\$1) and ((metal\$8 near pattern) or (bonding near pad\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/28 12:16
4	68	(optoelectronic and lens\$2) and ((solder near bump\$1) and ((metal\$8 near pattern) or (bonding near pad\$1)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/28 12:16